

AQ0502-02RTG

5V, 1.0pF, SOT523, Unidirectional TVS, Low Capacitance ESD protection

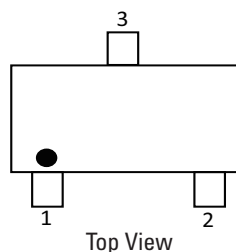


Description

The AQ0502-02RTG provides low capacitance, 2 channel unidirectional and a high level of protection for electronic equipment that may experience destructive electrostatic discharges (ESD). The typical capacitance of 1.0pF helps ensure excellent signal integrity on the most challenging consumer electronics interfaces, such as USB2.0, 10/100/1000 ethernet, display port.

It can safely absorb repetitive ESD strikes at ± 22 kV (contact discharge, IEC 61000-4-2) without performance degradation and safely dissipate 2.5 A of 8/20 μ s surge current (IEC 61000-4-5 2nd edition).

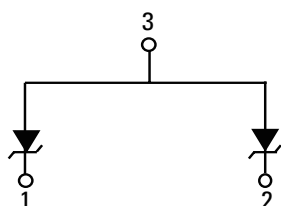
Pinout



Features

- ESD, IEC 61000-4-2, ± 22 kV contact, ± 27 kV air
- ESD, ISO 10605, 330 pF 330 Ω , ± 20 kV contact/air
- EFT, IEC 61000-4-4, 40 A (5/50 ns)
- Maximum surge tolerance, IEC 61000-4-5 2nd edition, 2.5 A (8/20 μ s)
- Low capacitance of 1 pF@1 MHz (Typ@V_R = 0 V)
- Low leakage current of 1 nA (Typ) at 5.0 V
- Halogen-free, lead-free and RoHS compliant
- Moisture sensitivity level (MSL-1)
- AEC-Q101 qualified and PPAP capable

Functional Block Diagram



Applications

- Automotive
- USB2.0
- Display port
- 10/100/1000 Ethernet

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

AQ0502-02RTG**5V, 1.0pF, SOT523, Unidirectional TVS, Low Capacitance ESD protection****Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
I_{PP}	Peak Current ($t_p = 8/20 \mu s$)	2.5	A
T_{OP}	Operating Temperature	-40 to 150	°C
T_{STOR}	Storage Temperature	-55 to 150	°C

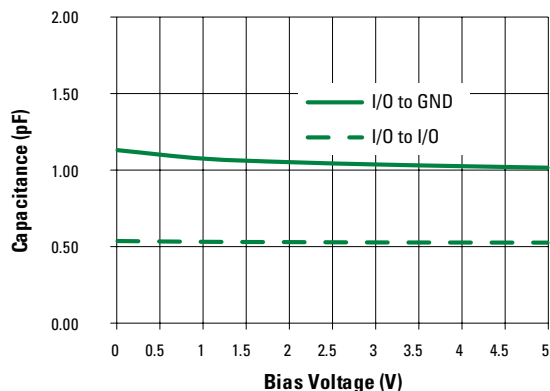
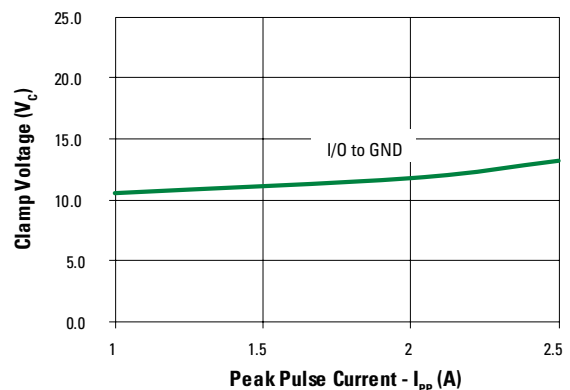
CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics ($T_{OP} = 25^\circ C$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V_{RWM}				5	V
Breakdown Voltage	V_{BR}	$I_R = 1 \text{ mA}$		8.2		V
Reverse Leakage Current	I_{LEAK}	$V_R = 5 \text{ V}$		1	50	nA
Clamp Voltage ¹	V_C	$I_{PP} = 1 \text{ A}$, $t_p = 8/20 \mu s$, I/O to GND		10.5		V
		$I_{PP} = 2.5 \text{ A}$, $t_p = 8/20 \mu s$, I/O to GND		13.2		V
Dynamic Resistance ^{1,2}	R_{DYN}	TLP, $t_p = 100 \text{ ns}$, I/O to GND		0.78		Ω
ESD Withstand Voltage ^{1,3}	V_{ESD}	IEC 61000-4-2 (Contact Discharge)	± 22			kV
		IEC 61000-4-2 (Air Discharge)	± 27			kV
		ISO10605 (Contact Discharge)	± 20			kV
		ISO10605 (Air Discharge)	± 20			kV
Diode Capacitance ¹	C_{IO-GND}	Reverse Bias = 0 V, $f = 1 \text{ MHz}$, I/O to GND		1.0		pF
	C_{IO-IO}	Reverse Bias = 0 V, $f = 1 \text{ MHz}$, I/O to I/O		0.6		pF

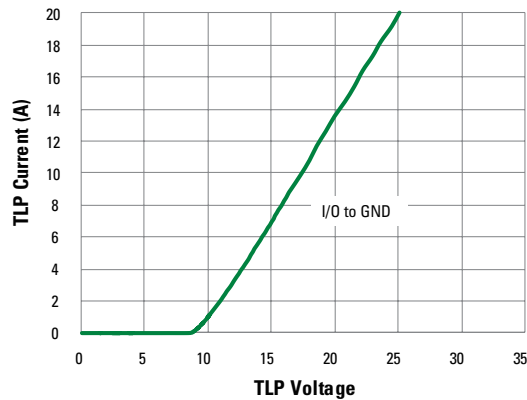
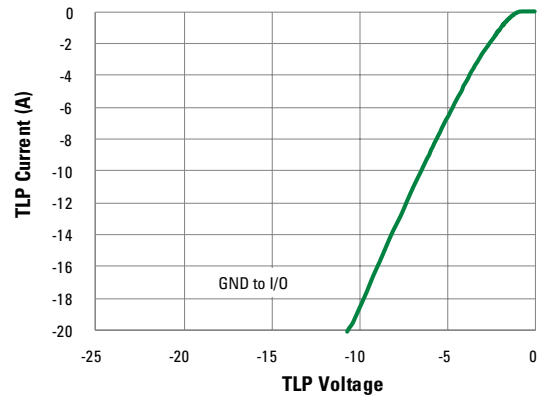
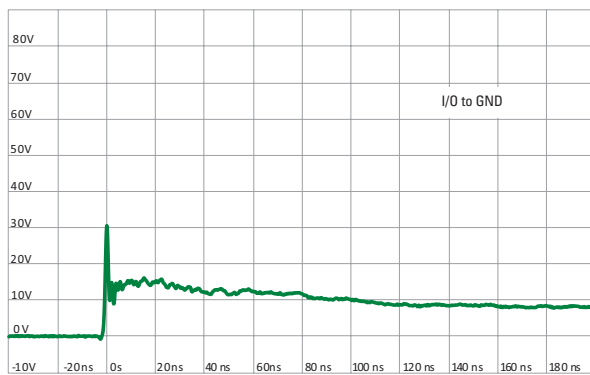
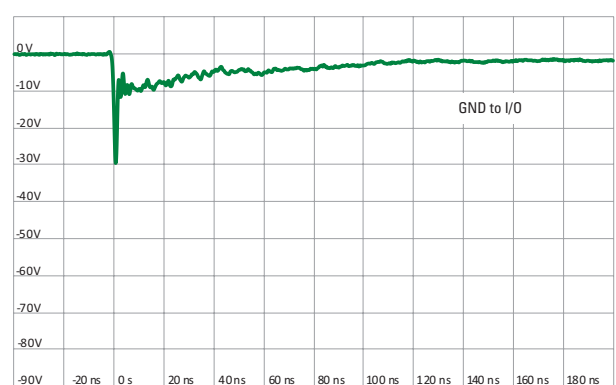
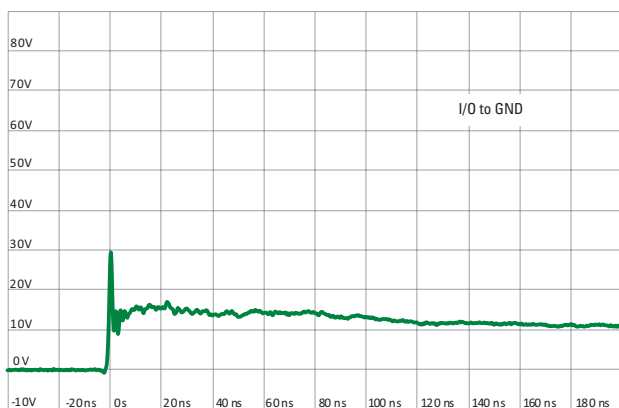
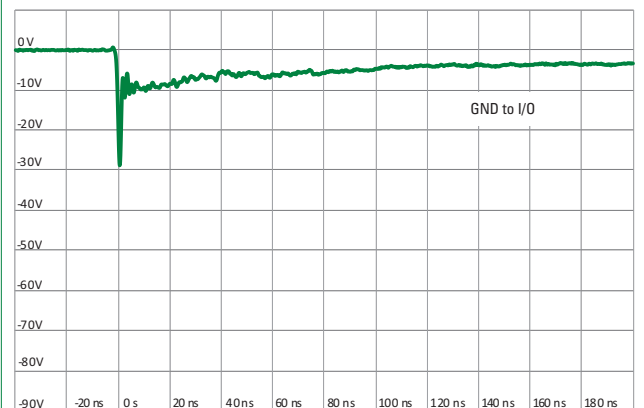
Note:

- Parameter is guaranteed by design and/or component characterization.
- Transmission Line Pulse (TLP) with 100ns width, 0.2 ns rise time, and average window $t_1 = 70 \text{ ns}$ to $t_2 = 90 \text{ ns}$.
- Device stressed with ten non-repetitive ESD pulses according to IEC61000-4-2 ($R = 330 \Omega$, $C = 150 \text{ pF}$).
- Device stressed with three non-repetitive ESD pulses according to ISO10605 ($R = 330 \Omega$, $C = 330 \text{ pF}$).

Capacitance vs. Reverse Bias**Clamping Voltage vs I_{PP}** 

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Positive Transmission Line Pulsing (TLP) Plot**Negative Transmission Line Pulsing (TLP) Plot****IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage****IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage****ISO10605 Contact Discharge Plot at +8 kV****ISO10605 Contact Discharge Plot at -8 kV**

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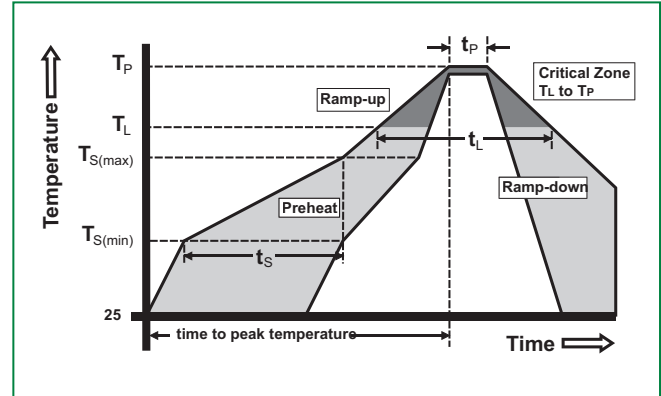
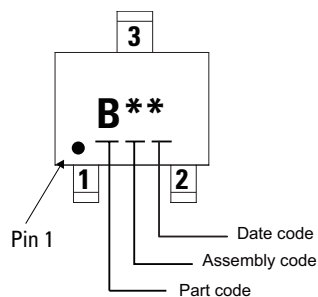
Soldering Parameters

Reflow Condition		Pb – free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150 °C
	- Temperature Max ($T_{s(max)}$)	200 °C
	- Time (min to max) (t_s)	60 – 120 seconds
Average Ramp up Rate (Liquidus) Temp (T_L) to Peak		3 °C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3 °C/second max
Reflow	- Temperature (T_L) (Liquidus)	217 °C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5 °C of Actual Peak Temperature (t_p)		30 seconds
Ramp-down Rate		6 °C/second max
Time 25 °C to Peak Temperature (T_p)		8 minutes max
Do Not Exceed		260 °C

Ordering Information

Part Number	Package	Min. Order Qty.
AQ0502-02RTG	SOT523-3L	3000

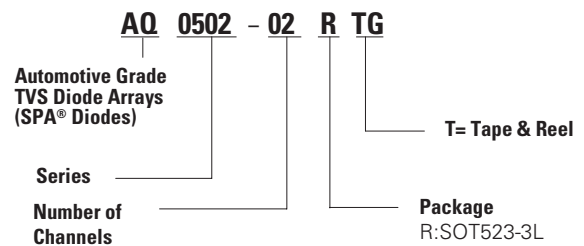
Part Marking System



Product Characteristics

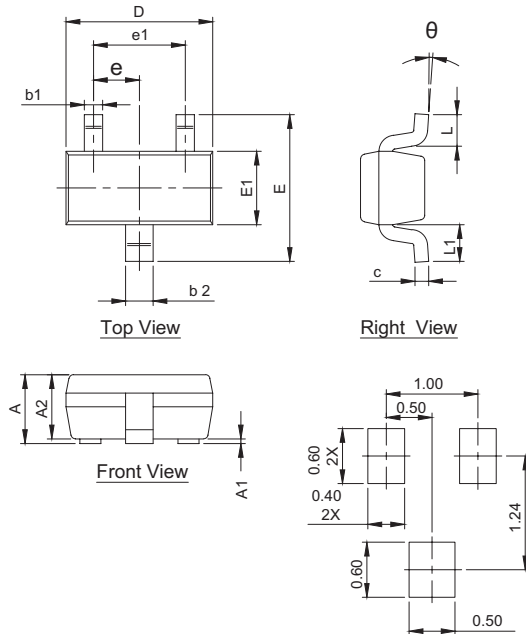
Lead Plating	Matte tin
Lead Material	Copper alloy
Body Material	Molded compound
Flammability	UL recognized compound meeting flammability rating V-0

Part Numbering System



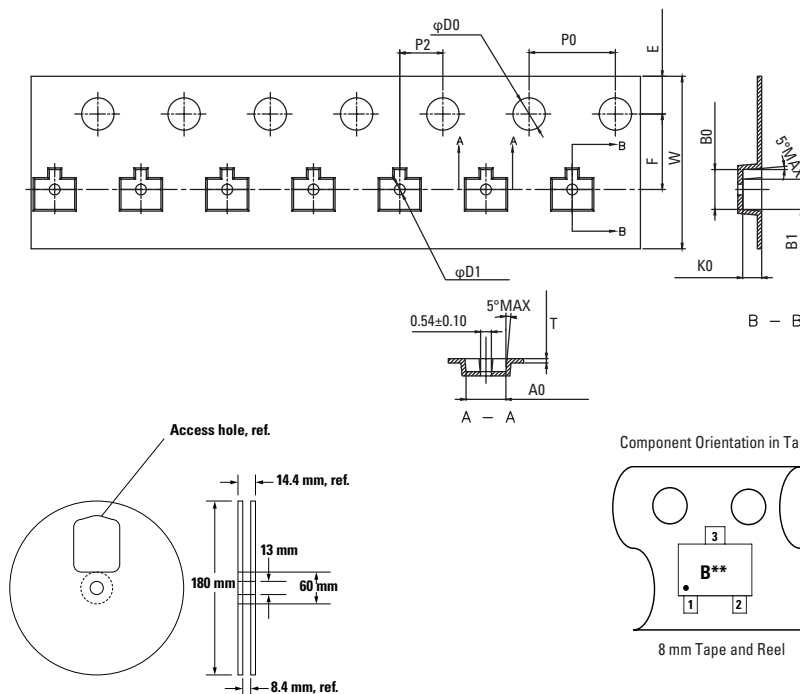
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Package Dimensions — SOT523-3L

Recommended Soldering Pattern (unit :mm)

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.700	0.900	0.0276	0.0354
A1	0.000	0.100	0.0000	0.0039
A2	0.700	0.800	0.0276	0.0315
b1	0.150	0.250	0.0059	0.0098
b2	0.250	0.350	0.0098	0.0138
c	0.100	0.200	0.0039	0.0079
D	1.500	1.700	0.0591	0.0669
E	1.450	1.750	0.0571	0.0689
E1	0.700	0.900	0.0276	0.0354
e	0.500 TYP		0.0197 TYP	
e1	0.900	1.100	0.0354	0.0433
L	0.260	0.460	0.0102	0.0181
L1	0.400 REF		0.0157 REF	
θ	0°	8°	0°	8°

Embossed Carrier Tape & Reel Specification — SOT523-3L

Symbol	Millimeters
A0	1.85+/-0.05
B0	1.85+/-0.05
B1	1.40+/-0.05
W	8.0+0.3/-0.10
D0	$\phi 1.50 \pm 0.10$
D1	$\phi 0.50 \pm 0.10$
E	1.75+/-0.10
F	3.50+/-0.05
P0	4.00+/-0.10
P2	2.00+/-0.05
K0	0.90+0.03
T	0.20+/-0.02

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